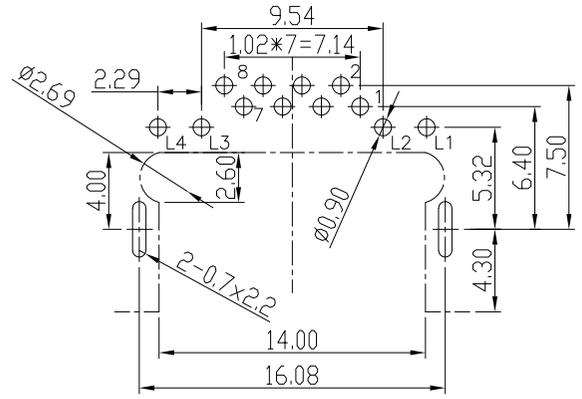
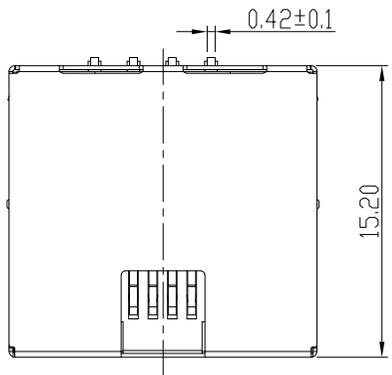
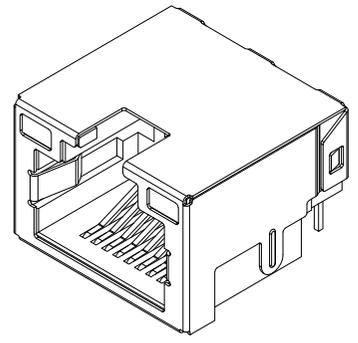
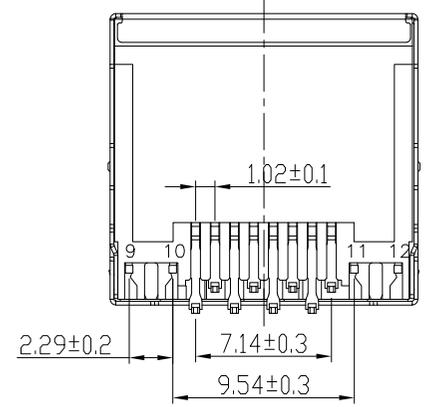
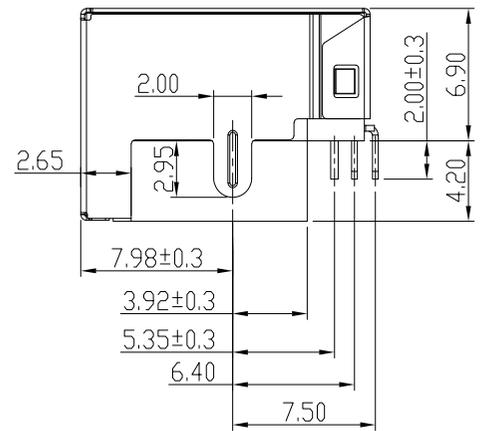
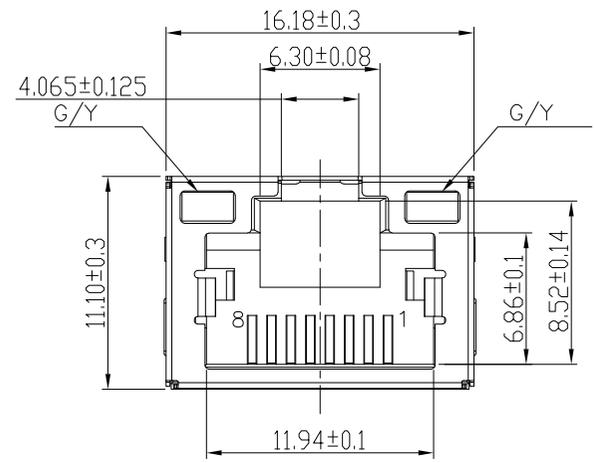


# GP Component

| REV. | ECN NO. | LOCATIONS | DESCRIPTION | DATE       | DESIGN   |
|------|---------|-----------|-------------|------------|----------|
| A0   |         |           | Initial     | 2019/02/13 | Phebe Su |

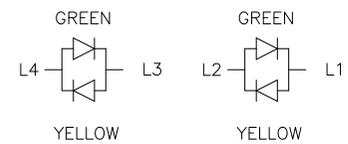


Recommend PCB Layout  
(Top View)  
TOLERANCES:±0.05

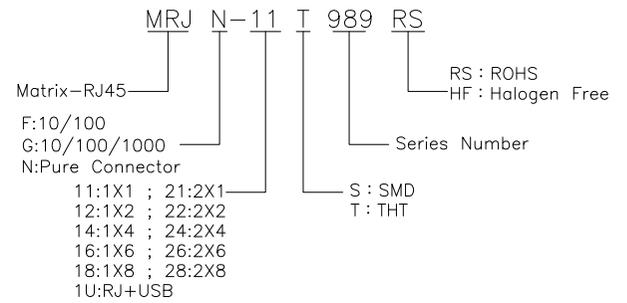


**NOTES:**

- MATERIALS:**  
HOUSING: LCP UL94V-0,COLOR BLACK, MIXED GLASS FIBER.  
CONTACTS: COPPER ALLOT T=0.3mm  
GOLD FLASH IN CONTACT AREA, Tin IN SOLDER TAIL AREA, BOTH OVER Ni UNDERPLATED OVERALL  
SHELL: Brass, T=0.2mm, Ni PLATED
- OPERATING TEMPERATURE:** -40°C~+85°C
- CAVITY CONFIRMS TO FCC RULES AND REGULATIONS PART 68,SUBPART F.**



**MATRIX PART NO:**



Matrix Electronics Co.,Ltd

|   |                                       |                             |   |               |
|---|---------------------------------------|-----------------------------|---|---------------|
| <b>TOLERANCE:</b><br>X.X ±0.38<br>X.XX ±0.25<br>X.XXX ±0.13<br>ANGLE: ±3° | <b>DESIGN BY :</b><br>Phebe Su        | <b>DATE :</b><br>2019/02/13 | <b>PART NAME:</b><br>RJ45 Shen plate TIP 8P8C |               |
| <b>APPROVED BY1:</b><br>Richard Hsieh                                     | <b>APPROVED BY2:</b><br>Richard Hsieh | <b>DATE :</b><br>2019/02/13 | <b>PART NO.</b>                               | MRJN-11T989RS |
| <b>UNIT: mm [inch]</b>  | <b>SCALE:1:1</b>                      | <b>SIZE:A4</b>              | <b>MOLD NO.</b>                               | NA            |
|   |                                       | <b>DATE :</b><br>2019/02/13 | <b>DRAW NO.</b>                               |               |
|   |                                       |                             | <b>SHEET NO.</b>                              | 1 OF 1        |